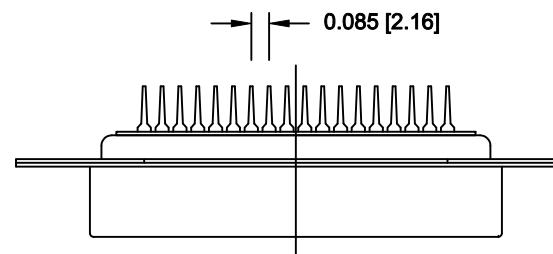
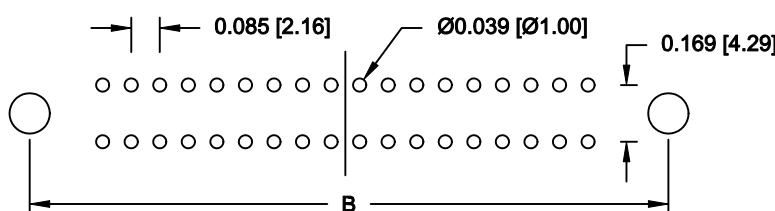
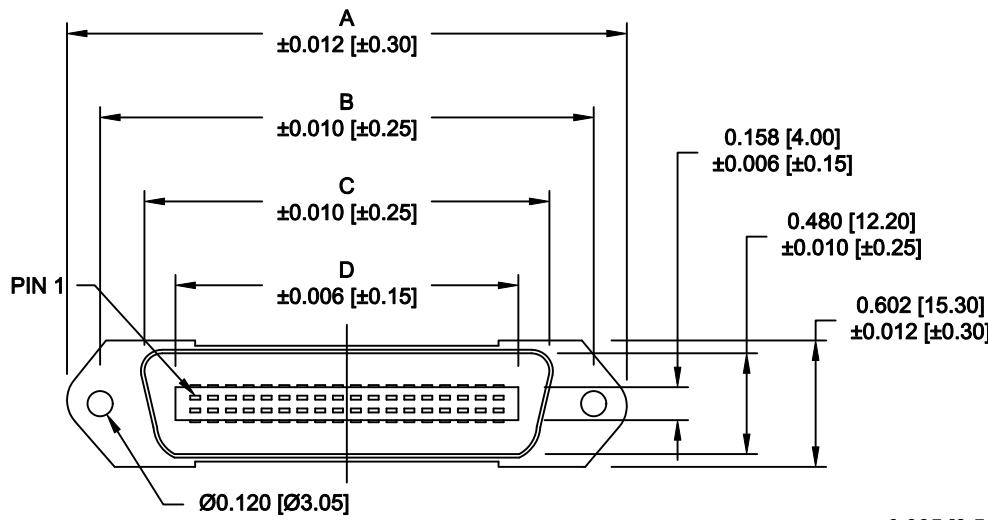


DESCRIPTION: 0.085 RIBBON - DIP SOLDER

36 PIN
SHOWN

	014	024	036	050
A	1.728	2.154	2.667	3.272
	43.90	54.70	67.75	83.10
B	1.417	1.843	2.352	2.947
	36.00	46.80	59.74	74.85
C	1.004	1.429	1.929	2.538
	25.50	36.30	49.00	64.47
D	0.689	1.102	1.634	2.207
	17.50	28.00	41.50	56.05



RECOMMENDED PCB LAYOUT

SCALE = 2 : 1

RoHS COMPLIANT



MATERIAL:

INSULATION: PBT - UL 94V-0 RATED

CONTACTS: PHOSPHOR BRONZE

CONTACT PLATING: GOLD FLASH IN THE MATING AREA
BRIGHT TIN IN THE SOLDER AREA

SHELL: STEEL, NICKEL PLATED

ELECTRICAL:

CURRENT RATING: 1 AMPS

VOLTAGE RATING: 1,000V AC r.m.s.

INSULATION RESISTANCE: 1,000MegOhms Min. @ 500VDC

CONTACT RESISTANCE: 30MilliOhms Max.

OPERATING TEMPERATURE: -55°C TO +125°C

111-YYY-113L001

SERIES
POSITIONS

014

024

036

050

GENDER

1 = MALE

TERMINATION

1 = DIP SOLDER

RoHS COMPLIANT

L = LOW TEMP. PROCESS

SHELL PLATING

3 = NICKEL

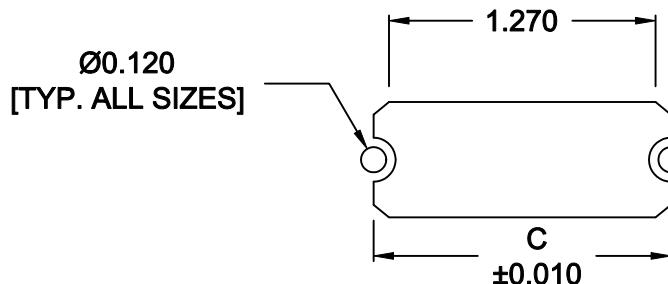
HARDWARE

00 = NO HARDWARE

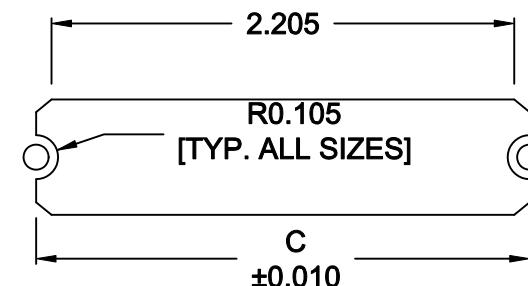
PLATING

1 = GOLD FLASH

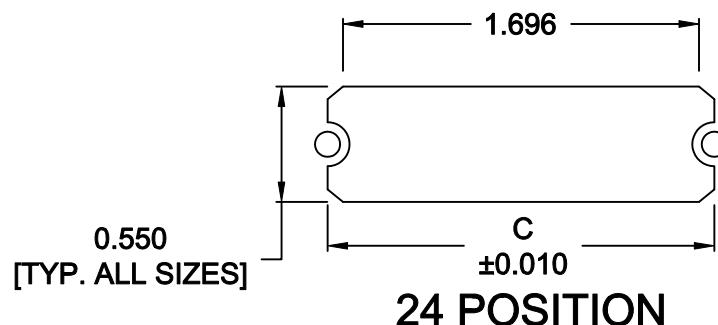
	014	024	036	050
C	1.417	1.843	2.352	2.947
	36.00	46.80	59.74	74.85



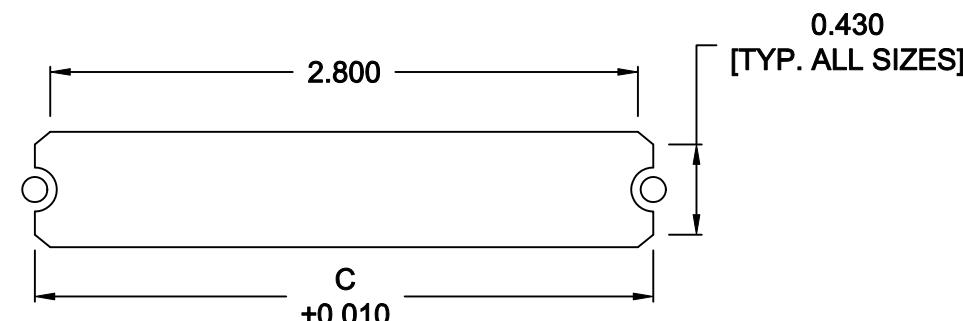
14 POSITION



36 POSITION



24 POSITION



50 POSITION

NOTEDIMENSION "C" =
CENTER TO CENTER OF MOUNTING HOLES
CENTER OF RADII
OVERALL LENGTH OF CUTOUT

RoHS COMPLIANT

DO NOT SCALE FROM DRAWING



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APPARATUS WITHOUT WRITTEN PERMISSION.

DRAWN:
M. SIGMON

DATE:
01-14-11

CHECKED:

DATE:

SCALE: **NONE** SHEET **2** OF **2** REV **10**

DWG NO. **111-YYY-113L001**

NorComp